

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Alpha & Omega Semiconductor Inc. AOZ8000HIL

For any questions, you can email us directly: sales@integrated-circuit.com





A0Z8000

Ultra-Low Capacitance TVS Diode Array

General Description

The AOZ8000 is a transient voltage suppressor array designed to protect high speed data lines from ESD and lightning.

This device incorporates eight surge rated, low capacitance steering diodes and a TVS in a single package. During transient conditions, the steering diodes direct the transient to either the positive side of the power supply line or to ground. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4. The TVS diodes provide effective suppression of ESD voltages: ±15kV (air discharge) and ±8kV (contact discharge).

The AOZ8000 comes in SOT-23, DFN-6, and SC-70 packages. They are compatible with both lead free and SnPb assembly techniques. The small size, low capacitance and high ESD protection makes it ideal for protecting high speed video and data communication interfaces.

Features

- ESD protection for high-speed data lines:
 - IEC 61000-4-2, level 4 (ESD) immunity test
 - ±15kV (air discharge) and ±8kV (contact discharge)
 - IEC 61000-4-5 (Lightning) 5A (8/20µs)
 - Human Body Model (HBM) ±15kV
- Small package saves board space
- Low insertion loss
- Protects four I/O lines
- Low capacitance between I/O lines: 0.9pF
- Low clamping voltage
- Low operating voltage: 5.0V

Applications

- USB 2.0 power and data line protection
- Video graphics cards
- Monitors and flat panel displays
- Digital Video Interface (DVI)
- 10/100/1000 Ethernet
- Notebook computers



Typical Application

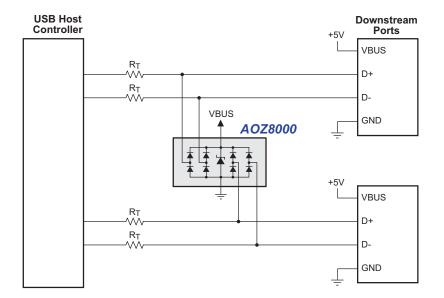


Figure 1. 2 USB High Speed Ports

Rev. 2.4 July 2010 **www.aosmd.com** Page 1 of 15



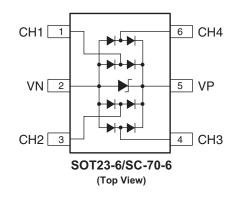
Ordering Information

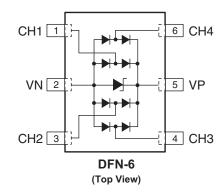
Part Number	Package	Environmental
AOZ8000HIL	SC-70-6	D 110 0 11 1
AOZ8000DIL	DFN-6	RoHS Compliant Green Prodcut
AOZ8000CIL	SOT23-6	Green reason



AOS Green Products (with "L" suffix) use reduced levels of Halogens, and are also RoHS compliant. Please visit www.aosmd.com/web/quality/rohs_compliant.jsp for additional information.

Pin Configuration





Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
VP – VN	6V
Peak Pulse Current (I _{PP}), t _P = 8/20μs	5A
Peak Power Dissipation (8 x 20μs@ 25°C)	
SC-70	60W
DFN	70W
SOT-23	60W
Storage Temperature (T _S)	-65°C to +150°C
ESD Rating per IEC61000-4-2, Contact ⁽¹⁾	±8kV
ESD Rating per IEC61000-4-2, Air ⁽¹⁾	±15kV
ESD Rating per Human Body Model ⁽²⁾	±15kV

Notes

- 1. IEC 61000-4-2 discharge with C_Discharge = 150pF, R_Discharge = 330 Ω .
- 2. Human Body Discharge per MIL-STD-883, Method 3015 $C_{Discharge}$ = 100pF, $R_{Discharge}$ = 1.5k Ω .

Maximum Operating Ratings

Parameter	Rating
Junction Temperature (T _J)	-55°C to +125°C

Rev. 2.4 July 2010 **www.aosmd.com** Page 2 of 15





Electrical Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{RWM}	Reverse Working Voltage	Between pin 5 and 2 ⁽⁴⁾			5.5	V
V _{BR}	Reverse Breakdown Voltage	I _T = 1mA, between pins 5 and 2 ⁽⁵⁾	6.6			V
I _R	Reverse Leakage Current	V _{RWM} = 5V, between pins 5 and 2			0.1	μΑ
V _F	Diode Forward Voltage	I _F = 15mA	0.70	0.85	1	V
V _{CL}	Channel Clamp Voltage Positive Transients Negative Transient	$I_{PP} = 1A$, $tp = 100$ ns, any I/O pin to Ground ⁽³⁾⁽⁶⁾⁽⁸⁾			10.0 -3.0	< <
	Channel Clamp Voltage Positive Transients Negative Transient	$I_{PP} = 5A$, tp = 100ns, any I/O pin to Ground ⁽³⁾⁽⁶⁾⁽⁸⁾			11 -6.0	V V
	Channel Clamp Voltage Positive Transients Negative Transient	$I_{PP} = 12A$, tp = 100ns, any I/O pin to Ground ⁽³⁾⁽⁶⁾⁽⁸⁾			15.0 -10.0	V V
C _j	Junction Capacitance	$V_R = 0V$, $f = 1MHz$, any I/O pin to Ground ⁽³⁾⁽⁶⁾		1.85	1.94	pF
		$V_R = 0V$, $f = 1MHz$, between I/O pins ⁽³⁾⁽⁶⁾		0.9	0.94	pF
		$V_R = 0V$, $f = 1MHz$, any I/O pin to Ground ⁽³⁾⁽⁷⁾		1.0	1.17	pF
ΔC _j	Channel Input Capacitance Matching	V _R = 0V, f = 1MHz, between I/O pins ⁽³⁾⁽⁶⁾			0.03	pF

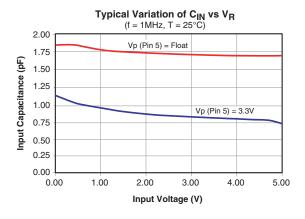
Notes:

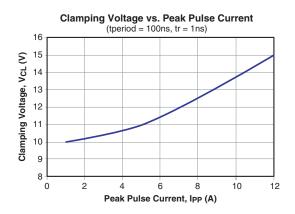
- 3. These specifications are guaranteed by design.
- 4. The working peak reverse voltage, V_{RWM} , should be equal to or greater than the DC or continuous peak operating voltage level.
- 5. V_{BR} is measured at the pulse test current I_{T} .
- 6. Measurements performed with no external capacitor on $V_{\mbox{\scriptsize P}}$ (pin 5 floating).
- 7. Measurements performed with V_{P} biased to 3.3 Volts (pin 5 @ 3.3V).
- 8. Measurements performed using a 100ns Transmission Line Pulse (TLP) system.

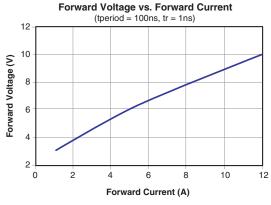
Rev. 2.4 July 2010 **www.aosmd.com** Page 3 of 15

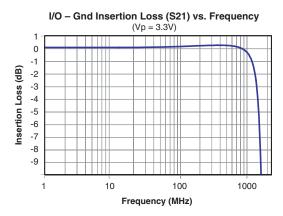


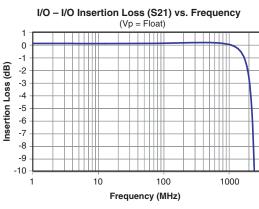
Typical Performance Characteristics

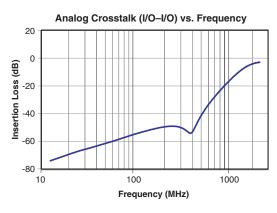


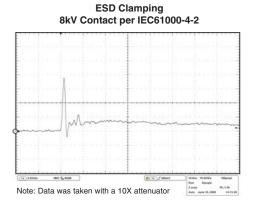












Rev. 2.4 July 2010 **www.aosmd.com** Page 4 of 15

Distributor of Alpha & Omega Semiconductor Inc.: Excellent Integrated System Limited Datasheet of AOZ8000HIL - TVS DIODE 5VWM 15VC SC706



AOZ8000

Application Information

The AOZ8000 TVS is design to protect four data lines from fast damaging transient over-voltage by clamping it to a reference. When the transient on a protected data line exceed the reference voltage the steering diode is forward bias thus, conducting the harmful ESD transient away from the sensitive circuitry under protection.

PCB Layout Guidelines

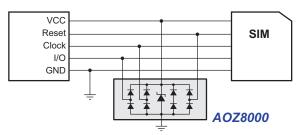
Printed circuit board layout is the key to achieving the highest level of surge immunity on power and data lines. The location of the protection devices on the PCB is the simplest and most important design rule to follow. The AOZ8000 devices should be located as close as possible to the noise source. The placement of the AOZ8000 devices should be used on all data and power lines that enter or exit the PCB at the I/O connector. In most systems, surge pulses occur on data and power lines that enter the PCB through the I/O connector. Placing the AOZ8000 devices as close as possible to the noise source ensures that a surge voltage will be clamped before the pulse can be coupled into adjacent PCB traces. In addition, the PCB should use the shortest possible traces. A short trace length equates to low impedance, which ensures that the surge energy will be dissipated by the AOZ8000 device. Long signal traces will act as antennas to receive energy from fields that are produced by the ESD pulse. By keeping line lengths as short as possible, the efficiency of the line to act as an antenna for ESD related fields is reduced. Minimize interconnecting line lengths by placing devices with the most interconnect as close together as possible. The protection circuits should shunt the surge voltage to either the reference or chassis ground. Shunting the surge voltage directly to the IC's signal ground can cause ground bounce. The clamping performance of TVS diodes on a single ground PCB can be improved by minimizing the impedance with relatively short and wide ground traces. The PCB layout and IC package parasitic inductances can cause significant overshoot to the TVS's clamping voltage. The inductance of the PCB can be reduced by using short trace lengths and multiple layers

with separate ground and power planes. One effective method to minimize loop problems is to incorporate a ground plane in the PCB design. The AOZ8000 ultra-low capacitance TVS is designed to protect four high speed data transmission lines from transient over-voltages by clamping them to a fixed reference. The low inductance and construction minimizes voltage overshoot during high current surges. When the voltage on the protected line exceeds the reference voltage the internal steering diodes are forward biased, conducting the transient current away from the sensitive circuitry.

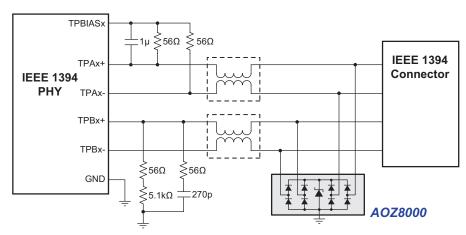
Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- 1. Place the TVS near the IO terminals or connectors to restrict transient coupling.
- 2. Fill unused portions of the PCB with ground plane.
- 3. Minimize the path length between the TVS and the protected line.
- 4. Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- 6. Never run critical signals near board edges.
- 7. Use ground planes whenever possible.
- 8. Avoid running critical signal traces (clocks, resets, etc.) near PCB edges.
- Separate chassis ground traces from components and signal traces by at least 4mm.
- 10. Keep the chassis ground trace length-to-width ratio <5:1 to minimize inductance.
- 11. Protect all external connections with TVS diodes.

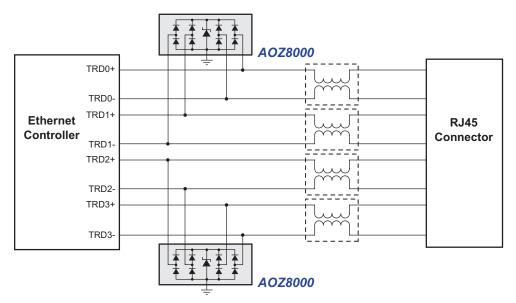




SIM Card Port Connection



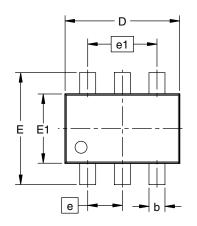
IEEE1394 Port Connection

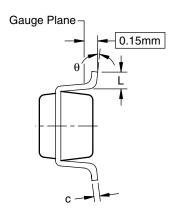


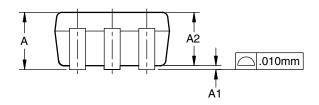
10/100 Ethernet Port Connection



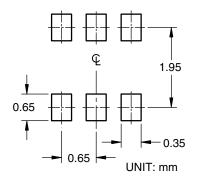
Package Dimensions, SC70-6L







RECOMMENDED LAND PATTERN



Dimensions in millimeters

Symbols	Min.	Nom.	Max.
Α		_	1.10
A1	0.00	_	0.10
A2	0.7	0.9	1.00
b	0.15	_	0.30
С	0.08	_	0.22
D	1.85	2.10	2.15
Е	1.80	2.30	2.40
е	().65 BSC	
e1	1	1.30 BSC	
E1	1.1	1.30	1.4
L	0.26	0.36	0.46
θ	0°	4°	8°

Dimensions in inches

Symbols	Min.	Nom.	Max.
Α		_	0.043
A1	0.00	_	0.004
A2	0.028	0.035	0.039
b	0.006	_	0.012
С	0.003	_	0.009
D	0.073	0.083	0.085
Е	0.071	0.091	0.094
е	0	.026 BS	С
e1	0	.051 BS	С
E1	0.043	0.051	0.055
L	0.010	0.014	0.018
θ	0°	4°	8°

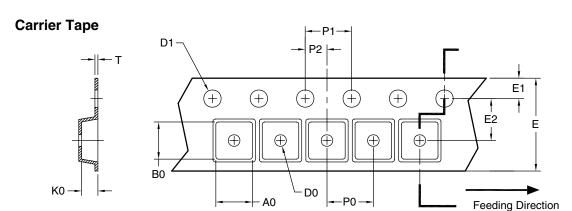
Notes:

- 1. All dimensions are in millimeters.
- 2. Dimensions are inclusive of plating
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 3 mils.
- 4. Die is facing up for mold and facing down for trim/form; i.e., reverse trim/form.
- 5. Dimension L is measured in gauge plane.
- 6. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

Rev. 2.4 July 2010 **www.aosmd.com** Page 7 of 15

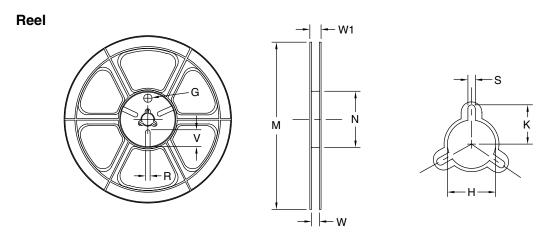


Tape and Reel Dimensions, SC70-6L



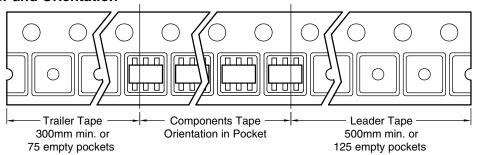
UNIT: mm

Package	A0	В0	K0	D0	D1	Е	E1	E2	P0	P1	P2	Т
SC-70, 6L	2.40	2.40	1.19	1.00	1.55	8.00	1.75	3.50	4.00	4.00	2.00	0.25
(8mm)	±0.10	±0.10	±0.10	Min.	±0.05	±0.30	±0.10	±0.05	±0.10	±0.10	±0.05	±0.05



Tape Size	Reel Size	М	N	W	W1	Н	K	S	G	R	V
8mm	ø180	ø180.00	ø60.50	9.00	11.40	ø13.00	10.60	2.00	ø9.00	5.00	18.00
		±0.50		±0.30	±1.00	+0.50/-0.20		±0.50			

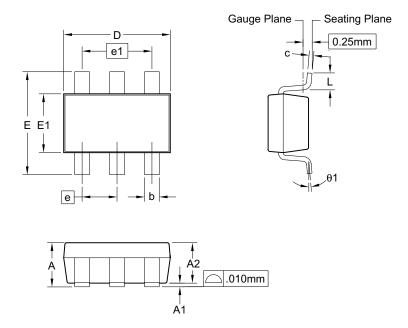
Leader/Trailer and Orientation



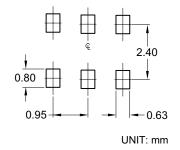
Rev. 2.4 July 2010 **www.aosmd.com** Page 8 of 15



Package Dimensions, SOT23-6L



RECOMMENDED LAND PATTERN



Dimensions in millimeters

Symbols	Min.	Nom.	Max.
Α	0.90	_	1.25
A1	0.00	_	0.15
A2	0.80	1.10	1.20
b	0.30	0.40	0.50
С	0.08	0.13	0.20
D	2.70	2.90	3.10
E	2.50	2.80	3.10
E1	1.50	1.60	1.70
е	().95 BSC	
e1	-	1.90 BSC	;
L	0.30	_	0.60
θ1	0°	_	8°

Dimensions in inches

	1010110		.00
Symbols	Min.	Nom.	Max.
Α	0.035	_	0.049
A1	0.00	_	0.006
A2	0.031	0.043	0.047
b	0.012	0.016	0.020
С	0.003	0.005	0.008
D	0.106	0.114	0.122
E	0.098	0.110	0.122
E1	0.059	0.063	0.067
е	0	.037 BS	С
e1	0	.075 BS	С
L	0.012	_	0.024
θ1	0°	_	8°

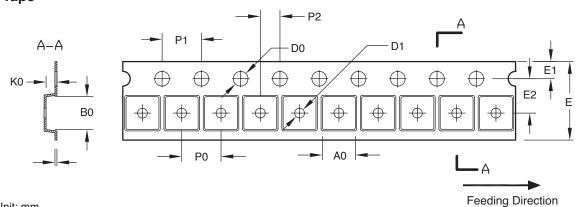
Notes:

- 1. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils each.
- 2. Dimension "L" is measured in gauge plane.
- 3. Tolerance ± 0.100 mm (4 mil) unless otherwise specified.
- 4. Followed from JEDEC MO-178C & MO-193C.
- 6. Controlling dimension is millimeter. Converted inch dimensions are not necessarily exact.



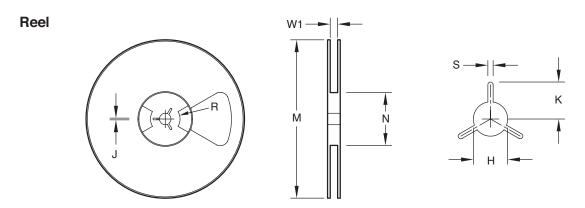
Tape and Reel Dimensions, SOT23-5&6L

Tape



Unit: mm

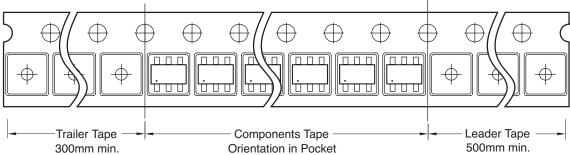
Package	A0	В0	K0	D0	D1	Е	E1	E2	P0	P1	P2	Т
SOT23-5/6L	3.15	3.20	1.40	1.50	1.00	8.00	1.75	3.50	4.00	4.00	2.00	0.23
LP	±0.10	±0.10	±0.10	±0.05	+0.10 / -0	±0.30	±0.10	±0.05	±0.10	±0.10	±0.05	±0.03



Unit: mm

Tape Size	Reel Size	М	N	W1	Н	S	K	R	J
8mm	ø177.8	ø177.8 Max.	55.0 Min.	8.4 +1.50 / -0.0	13.0 +0.5 / -0.2	1.5 Min	10.1 Min.	12.7	4.0 ±0.1

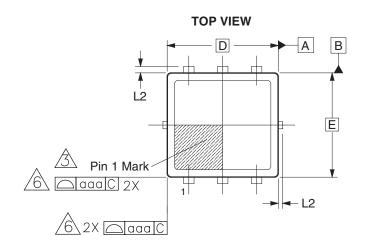
Leader/Trailer and Orientation

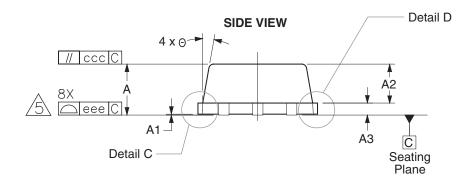


Rev. 2.4 July 2010 www.aosmd.com Page 10 of 15

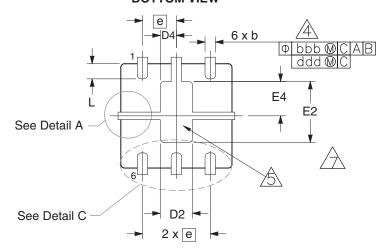


Package Dimensions, DFN 2 x 2 (Page 1 of 3)





BOTTOM VIEW

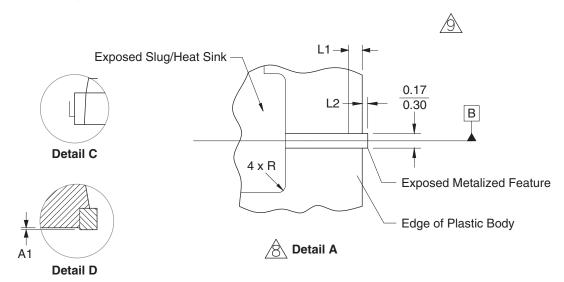


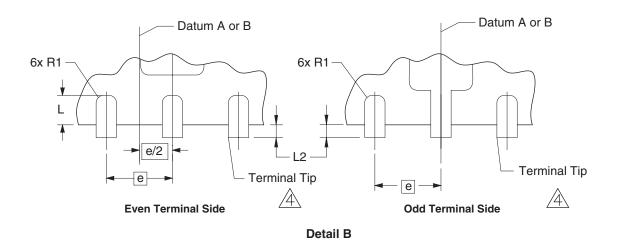
Rev. 2.4 July 2010 **www.aosmd.com** Page 11 of 15



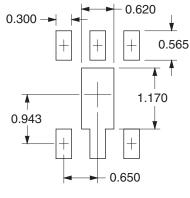


Package Dimensions, DFN 2 x 2 (Page 2 of 3)





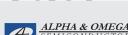
RECOMMENDED LAND PATTERN



Unit: mm

Rev. 2.4 July 2010 **www.aosmd.com** Page 12 of 15





Package Dimensions, DFN 2 x 2 (Page 3 of 3)

Dimensions in millimeters

Symbols Min. Nom. Max. 0.90 1.00 0.80 Α Α1 0.00 0.025 0.05 A2 0.65 0.70 0.75 АЗ 0.15 0.20 0.25 0.18 0.20 0.28 b D 2.0 BSC Ε 2.0 BSC 0.65 BSC е E4 0.56 0.66 0.76 0.84 0.94 1.04 0.31 0.41 D4 0.21 0.52 0.62 0.72 D₂ 0.20 0.29 Т 0.45 L1 L2 0.125 0.075 REF R 0.075 REF R1 R2 0.10 aaa bbb 0.10 0.10 CCC 0.05 ddd 0.08 eee 10° θ 0° 12°

Dimensions in inches

2									
Symbols	Min.	Nom.	Max.						
Α	0.031	0.035	0.039						
A1	0.000	0.001	0.002						
A2	0.026	0.028	0.030						
А3	0.006	0.008	0.010						
b	0.007	0.008	0.011						
D	0	.079 BS	С						
E	0	.079 BS	С						
е	0	.026 BS	С						
E4	0.022	0.026	0.030						
E2	0.033	0.037	0.041						
D4	0.008	0.012	0.016						
D2	0.020	0.024	0.028						
L	0.008	0.011	0.018						
L1	<u> </u>								
L2	— — 0.00								
R	0	0.003 REF							
R1	0	.003 RE	F						
R2	_								
aaa	0.004								
bbb	0.004								
ccc	0.004								
ddd	0.002								
eee	0.003								
θ	0° 10° 12°								

Notes:

- 1. Dimensioning and tolerances conform to ASME Y14.5M-1994.
- 2. All dimensions are in millimeters. All angles are in degrees.

3. The terminal #1 identifier and terminal numbering convention shall conform to JESD 95-1 SPP-012. Details of terminal #1 are optional, but must be located within the zone indicated. The terminal #1 identifier may be a molded, marked, or metalized feature.

4. Dimension b apply to metallized terminal and is measured between 0.15mm and 0.20mm from terminal tip.

 $\sqrt{5}$. Coplanarity applies to the exposed heat sink slug as well as the terminal.

Profile tolerance (aaa) will be applicable only to the plastic body, and not to the metallized fetures (such as terminal tips and tie bars.)

Metallized features may protrude a maximum of L2 from the plastic body profile.

7. Corners will be sharp unless otherwise specified with radius dimensions.

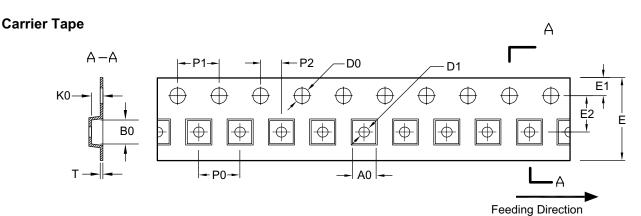
8. This feature applies to both ends of the package.

 $\sqrt{9}$. If L1 max. is not called out, the metalized feature will extend to the exposed pad. Thus, the 0.17mm gap does not apply.

Rev. 2.4 July 2010 **www.aosmd.com** Page 13 of 15



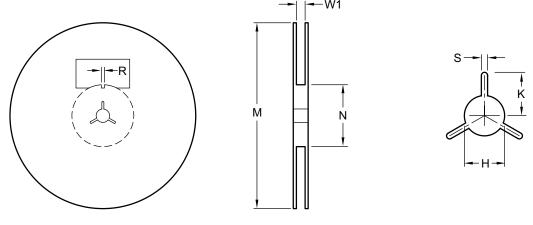
Tape and Reel Dimensions, DFN 2 x 2



UNIT: mm

Package	A0	В0	K0	D0	D1	E	E1	E2	P0	P1	P2	Т
DFN 2x2	2.25	2.25	1.00	1.50	1.00	8.00	1.75	3.50	4.00	4.00	2.00	0.254
	±0.05	±0.05	±0.05	+0.10/-0	+0.25/-0	+0.30/-0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.02

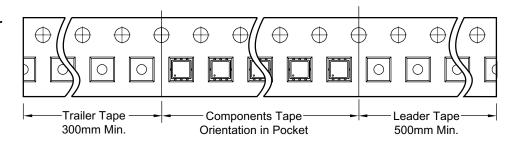




UNIT: mm

Tape Size	Reel Size	М	N	W1	H	s	K	R
8mm	ø180	ø180.00		8.4	13.0	1.5	13.5	3.0
		±0.50	±0.50	+1.5/-0.0	±0.20	Min.	Min.	±0.50

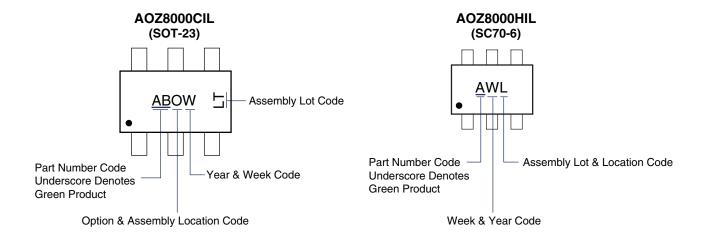
Leader / Trailer & Orientation

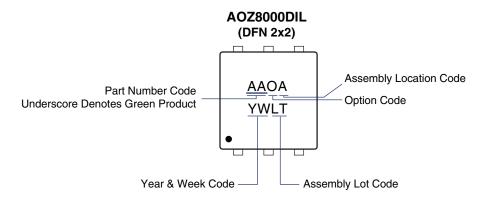


Rev. 2.4 July 2010 **www.aosmd.com** Page 14 of 15



Part Marking





This datasheet contains preliminary data; supplementary data may be published at a later date. Alpha & Omega Semiconductor reserves the right to make changes at any time without notice.

LIFE SUPPORT POLICY

ALPHA & OMEGA SEMICONDUCTOR PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS.

As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Rev. 2.4 July 2010 **www.aosmd.com** Page 15 of 15